# search of neutrinoless double beta decay

**Cryogenic light detectors for the** 

I. Colantoni<sup>a,d\*</sup>, F. Bellini<sup>a,b</sup>, L. Cardani<sup>a,c</sup>, N. Casali<sup>a,b</sup>, M.G. Castellano<sup>d</sup>, A. Coppolecchia<sup>a</sup>, C. Cosmelli<sup>a,b</sup>, A. Cruciani<sup>a,b</sup>, A. D'Addabbo<sup>e</sup>, S. Di Domizio<sup>f,g</sup>, M. Martinez<sup>a</sup>, C. Tomei<sup>b</sup> and M. Vignati<sup>a,b</sup>

a) Physics Department, Sapienza University of Rome, Rome, Italy – b) INFN – Sezione di Roma, Rome, Italy – c) Physics department, Princeton university, Princeton, NJ USA – d) IFN-CNR, Rome, Italy – e) INFN Laboratori Nazionali del Gran Sasso, Assergi (AQ) Italy – f) Physics department, Genova University, Genova, Italy – g) INFN – Sezione di Genova, Genova, Italy

— Abstract

**KIDs** 

KID1

INFN

UNIVERSITÀ DEGLI STUI

CALDER (Cryogenic wide-Area Light Detectors with Excellent Resolution) is a project for the development of large area phonon mediated KIDs (Kinetic Inductance Detectors), for the detection of Cherenkov radiation emitted from βs in 0vDBD decay in TeO2.

**PRINCETON** UNIVERSITY

The KIDs are superconducting detectors made of high quality factor superconducting resonators, which are coupled to a transmission line for signal readout.

We designed and fabricated KIDs using aluminum. The Al thin films (40 nm) were evaporated on Si(100) high resistivity silicon wafers using an electron beam evaporator in a HV chamber.

In this work we report the steps of the fabrication process. All devices are made in direct-write using Electron Beam Lithography (EBL), positive tone resist poly-methyl methacrylate (PMMA) and lift off process.

In order to improve the sensitivity of the detectors we have started recently to use sub-stoichiometric TiN deposited by means of DC magnetron sputtering and we will optimize a different fabrication process.

— KID working principle -

\* colanton@roma1.infn.it

Kinetic Inductance Detectors are superconducting microresonator devices with very high Q factors (10<sup>4</sup>-10<sup>6</sup>) and resonant frequency typically between 1-10 GHz

The interaction of a photon or a phonon with the detector breaks Cooper pairs, modifying the inductance and therefore amplitude and phase of resonator transmission (S<sub>21</sub>) when coupled to transmission line

Main advantages of this technology are represented by: excellent intrinsic energy resolution, relatively simple signal readout and easy scalability by a frequency multiplexing, excellent reliability

— CALDER project

Only limit of KIDs: poor active surface

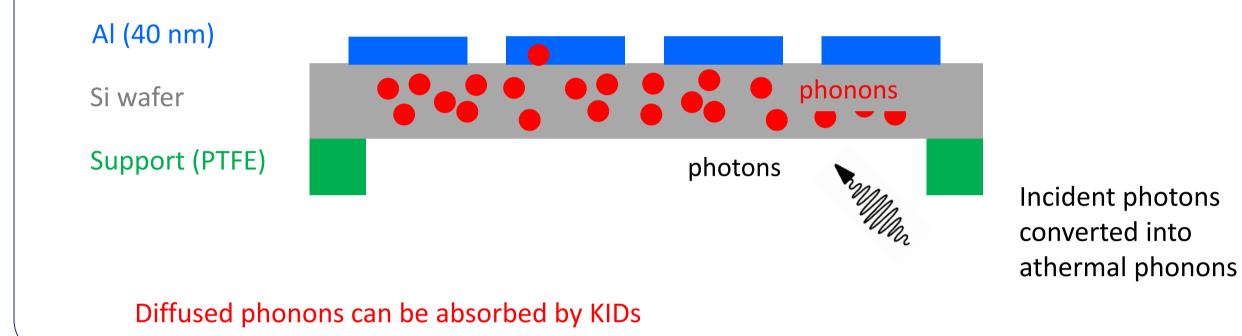
indirect detection of phonons produced by photons interactions in the substrate



KID3

high-resistivity Si substrate 2x2 cm<sup>2</sup> chip-size sampled by 9 or 4 pixels Single pixel active area ~ 2 mm<sup>2</sup> Resonant frequency: ~ 2.5 GHz





### Fabrication



PMMA is patterned
by EBL at 100 keV
beam energy and
90 nA gun current,
with a typical
exposure dose
ranging from 450
to 550 μC/cm<sup>2</sup>
depending on the
extension of the
area to be exposed

### EBL Leica/Vistec EBPG 5000



To remove native oxide from the silicon areas to be covered with AI the silicon substrate is dipped in dilute HF at 2% for 10 sec, then the sample is covered with a 40 nm Aluminum layer using electron gun evaporation in HV chamber

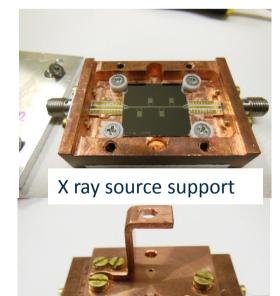
#### | Electron beam

PMMA 300 nm \_\_\_\_\_Si(100) ~ 300 μm

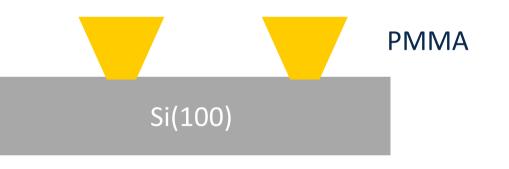
Exposed PMMA is removed by developer solution of MIBK:IPA 1:1 for 90 sec



Oxford RIE

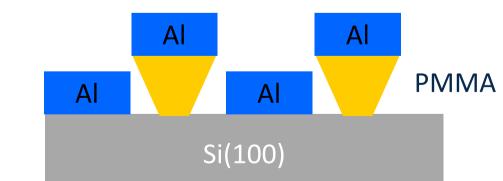


Cleaning using RIE with oxygen plasma to obtain an undercut in the PMMA profile



Detector in its holder and electrically connected to the SMA read out

Back side of detectors is illuminated with sources



e-resist under the Al lm is dissolved and takes the Al film with it

acetone to achieve lift-off: the

Al

Si(100)

After the Al deposition, the

wafer is immersed in hot



(x-ray and light)

iu iigiit*)* 

## Titanium nitride

evaporator

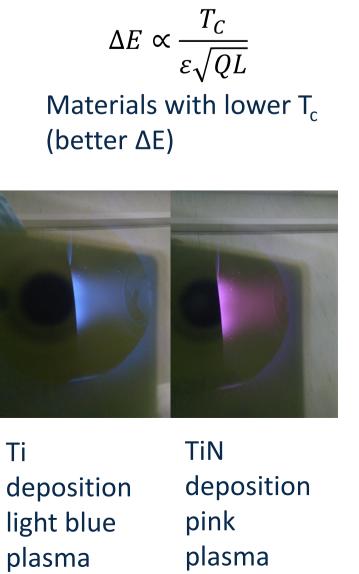
	Al	TiN <sub>x</sub>	Ti+TiN	Hf
Тс (К)	1,20	0,50*	0,40*	0,12
L (pH/sq)	0,05	3	30	3

\*tunable



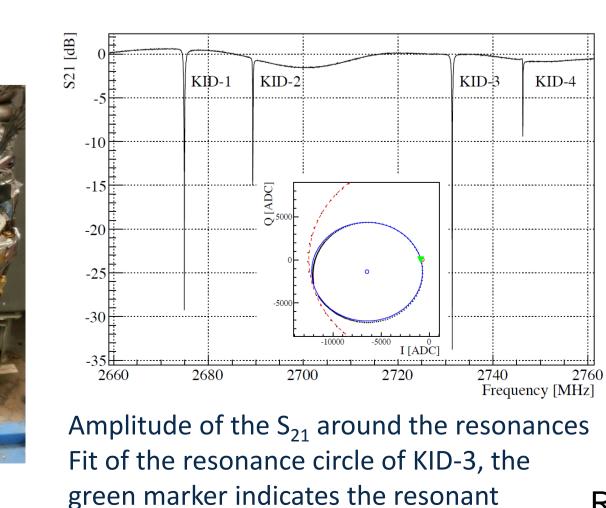
Sputtering HV chamber with Titanium target

TiN will be deposited with reactive nitrogen in plasma



Cryogenic setup 15 mK dilution refrigerator Readout electronics up to 12 resonator @ 2 MHz bandwidth

Results



frequency (inset)

	f <sub>o</sub> [GHz]	Q *10 <sup>3</sup>	P <sub>in</sub> [dBm]
KID1	2,675	6	-63
KID2	2,689	18	-64
KID3	2,731	8	-66
KID4	2,746	35	-72

References

http://arxiv.org/abs/1505.01318 http://arxiv.org/abs/1505.04666

13<sup>th</sup> Pisa Meeting on Advanced Detectors La Biodola, Isola d'Elba (Italy) May 24 - 30, 2015